



#### 300mW DUAL SURFACE MOUNT ZENER DIODE

#### **Features**

- Dual Zeners in Common Cathode Configuration
- 300 mW Power Dissipation
- Ideally Suited for Automated Insertion
- $\Delta V_Z$  For Both Diodes in One Case is  $\leq 5\%$
- Common Anode Style Available, See AZ Series
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

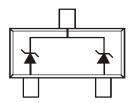
### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 lead frame (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)

SOT23



Top View



**Device Schematic** 

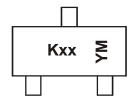
### Ordering Information (Note 5)

Device	Qualification	Packaging	Shipping		
(Type Number)-7-F*	Commercial	SOT23	3000/Tape & Reel		
(Type Number)Q-7-F*	Automotive	SOT23	3000/Tape & Reel		

<sup>\*</sup>Add "-7-F" to the appropriate type number in Electrical Characteristics Table on Page 2. Example: 6.2V Zener = DZ23C6V2-7-F.

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code OW (week 42, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code OW are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants. 5. For Packaging Details, go to our website at http://www.diodes.com/products/packages.html

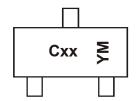
## **Marking Information**



K = SAT (Shanghai Assembly / Test site) xx = Product Type Marking Code See Electrical Characteristics Table YM = Date Code Marking

Y = Year (ex: Z = 2012)

M = Month (ex: 9 = September)



C = CAT (Chengdu Assembly / Test site) xx = Product Type Marking Code See Electrical Characteristics Table YM = Date Code Marking

Y = Year (ex: Z = 2012)

M = Month (ex: 9 = September)

Date Code Key

Year	1998		2002	2003	2004		2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	J		N	Р	R		Х	Υ	Z	Α	В	С	D	Е	F
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D



### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 6)	$P_{D}$	300	mW
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{\theta JA}$	417	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

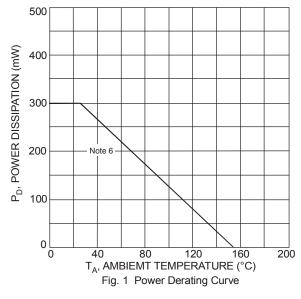
Notes: 6. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com.

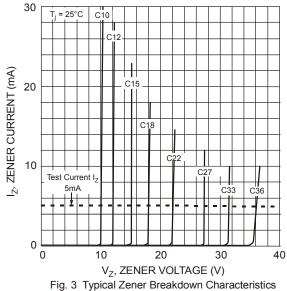
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Type Marking Number Code		Zener Voltage Range (Note 7)	Zener Im	mum npedance IkHz	Typical Temperature Coefficient	Min. Reverse Voltage (Note 7)
Number	Code	@ $I_{ZT} = 5.0 mA$	$Z_{ZT} @ I_{ZT} = 5.0 \text{mA}$ $Z_{ZK} @ I_{ZK} = 1.0 \text{mA}$		Coefficient	$@ I_R = 0.1 \mu A$
		V <sub>Z</sub> (V)	Ω	Ω	TC (%/°C)	V <sub>R</sub> (V)
DZ23C2V7	V1	2.5-2.9	83	500	-0.065	_
DZ23C3V0	V2	2.8-3.2	95	500	-0.060	_
DZ23C3V3	V3	3.1-3.5	95	500	-0.055	_
DZ23C3V6	V4	3.4-3.8	95	500	-0.055	_
DZ23C3V9	V5	3.7-4.1	95	500	-0.050	_
DZ23C4V3	V6	4.0-4.6	95	500	-0.035	
DZ23C4V7	V7	4.4-5.0	78	500	-0.015	_
DZ23C5V1	V8	4.8-5.4	60	480	+0.005	0.8
DZ23C5V6	V9	5.2-6.0	40	400	+0.020	1.0
DZ23C6V2	VA	5.8-6.6	10	200	+0.030	2.0
DZ23C6V8	VB	6.4-7.2	8.0	150	+0.045	3.0
DZ23C7V5	VC	7.0-7.9	7.0	50	+0.050	5.0
DZ23C8V2	VD	7.7-8.7	7.0	50	+0.055	6.0
DZ23C9V1	VE	8.5-9.6	10	50	+0.065	7.0
DZ23C10	VF	9.4-10.6	15	70	+0.065	7.5
DZ23C11	VG	10.4-11.6	20	70	+0.070	8.5
DZ23C12	VH	11.4-12.7	20	90	+0.075	9.0
DZ23C13	VI	12.4-14.1	25	110	+0.080	10.0
DZ23C15	VJ	13.8-15.6	30	110	+0.080	11.0
DZ23C16	VK	15.3-17.1	40	170	+0.090	12.0
DZ23C18	VL	16.8-19.1	50	170	+0.090	14.0
DZ23C20	VM	18.8-21.2	50	220	+0.090	15.0
DZ23C22	VN	20.8-23.3	55	220	+0.090	17.0
DZ23C24	VO	22.8-25.6	80	220	+0.090	18.0
DZ23C27	VP	25.1-28.9	80	250	+0.090	20.0
DZ23C30	VQ	28-32	80	250	+0.090	22.5
DZ23C33	VR	31-35	80	250	+0.090	25.0
DZ23C36	VS	34-38	90	250	+0.090	27.0
DZ23C39	VT	37-41	90	300	+0.110	29.0
DZ23C43	VU	40-46	100	700	+0.110	32.0
DZ23C47	VV	44-50	100	750	+0.110	35.0
DZ23C51	VW	48-54	100	750	+0.110	38.0

Notes: 7. Short duration pulse test used to minimize self-heating effect.







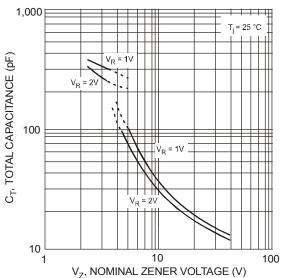


Fig. 5 Typical Total Capacitance vs. Nominal Zener Voltage

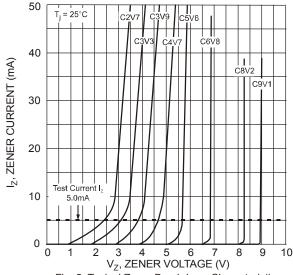


Fig. 2 Typical Zener Breakdown Characteristics

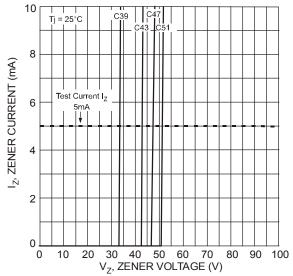
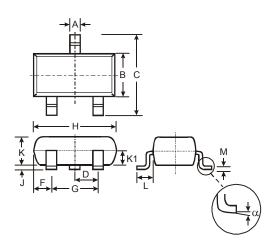


Fig. 4 Typical Zener Breakdown Characteristics



# **Package Outline Dimensions**

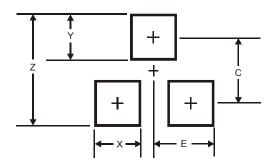
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	_	_	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	_				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	8.0
Υ	0.9
С	2.0
Е	1.35



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